



**ICCCAS
2026**

2026 15th International Conference on Communications, Circuits, and Systems

Takasaki, Japan
July 7-10, 2026

ICCCAS 2026 will focus on the latest challenges and emerging trends in communications, circuits, and systems, encompassing but not limited to topics such as communication technologies, circuit design, and system applications. The conference will feature keynote speeches, invited talks, technical paper presentations, and academic workshops, providing an excellent platform for participants to showcase research achievements, exchange ideas, and explore industrial trends.

Keynote Speaker



Prof. Xiaoqing Wen
Kyushu Institute of Technology, Japan
Fellow of IEEE



Prof. Jinhong Yuan,
University of New South Wales, Australia
Fellow of IEEE




Prof. Tetsuya Iizuka
University of Tokyo, Japan

SPECIAL SESSIONS

- SPECIAL SESSION 1** Analog/Mixed-Signal/RF/Power Circuits and Related Technologies in the Digital Society
Chair: Haruo Kobayashi, Gunma University, Japan
- SPECIAL SESSION 2** Information and Communication Technology in Optics and Photonics
Chairs: Feng Wen, University of Electronic Science and Technology of China, China
- SPECIAL SESSION 3** Radar/Sonar Environmental Observation, Communication and Remote Sensing
Chair: Jiahua Zhu, National University of Defense Technology, China
- SPECIAL SESSION 4** 6G Wireless Communication Networks
Chair: Jie Huang, Southeast University, China
- SPECIAL SESSION 5** Multi-Scale and Multi-Modal Communication Systems for Future Networks
Chairs: Yu Huang, Guangzhou University, China & Miaowen Wen, South China University of Technology, China & Xuan Chen, Guangzhou University, China
- SPECIAL SESSION 6** Air-Space-Ground-Maritime Integrated Wireless Communications
Chair: Ziyi Yang, Beijing Institute of Technology, China
- SPECIAL SESSION 7** AI-Driven Intelligent Spectrum Analysis and Management
Chair: Zan Li, Jilin University, China
- SPECIAL SESSION 8** AI-driven Data Compression
Chair: Yong Fang, Chang'an University, China
- SPECIAL SESSION 9** Environment-Aware Communication and Sensing for Low-altitude Networks
Chairs: Ruoguang Li, Hohai University, China
Benedetta Picano, University of Florence, Italy
Yu Zhang, University College London, United Kingdom

Publication

The accepted and presented papers will be published in the ICCCAS Conference Proceedings.  Conference content will be submitted for inclusion into IEEE Xplore and indexed by Ei Compendex and Scopus, as well as other Abstracting and Indexing (A&I) databases.

SCI/EI/Scopus Journal Publication



1.Chinese Journal of Electronics (ISSN: 1022-4653)
Indexing: SCIE (Web of Science), Scopus, Ei Compendex, Chemical Abstracts (CA), Inspec, etc.



2.电子学报 (ISSN: 0372-2112)
中文核心期刊
CCF推荐中文科技期刊A类
Indexing: Scopus, Ei Compendex, Inspec



3.Journal of Communications and Information Networks (ISSN: 2096-1081)
Indexing: SCIE (Web of Science), Scopus, Ei Compendex, Chemical Abstracts (CA), Inspec, etc.



4.Journal of Marine Science and Application (ISSN: 1671-9433)
Indexing: Scopus, Google Scholar, SCImago, CSA, CSCD, CJCR



5.IET Communications (ISSN: 1751-8636)
Impact Factor: 1.6
CiteScore(2022): 4.0
Indexing: SCIE, Ei, Scopus, Inspec, ACM, DOAJ



6.IET Quantum Communication (ISSN: 2632-8925)z
CiteScore(2022): 3.8
Indexing: Ei, Scopus, Inspec, DOAJ



7.Journal of Communications (ISSN: 1796-2021)
CiteScore: 2.3
Abbreviated Title: J. Commun.
Indexing: Scopus, DBLP; CrossRef, EBSCO, Google Scholar; CNKI, etc.

ICCCAS 2026 TRACKS

- Track 1. Secure and Trustworthy Communications**
Chair: Liang Xiao, Xiamen University, China
Co-Chair: Yao Liu, University of South Florida, USA
Co-Chair: Weizhi Meng, Lancaster University, UK
- Track 2. AI-Driven Communications & Semantic Networking**
Chair: Kai Niu, Beijing University of Posts and Telecommunications, China
Co-Chair: Jincheng Dai, Beijing University of Posts and Telecommunications, China
Co-Chair: Shuo Shao, University of Shanghai for Science and Technology, China
- Track 3. Satellite, Aerial, and Terrestrial Network Integration**
Chair: Rongke Liu, Beihang University, China
Co-Chair: Yuan Jiang, Sun Yat-sen University, China
Co-Chair: Nan Wu, Beijing Institute of Technology, China
- Track 4. Millimeter-Wave and Terahertz Communication**
Chair: Yaxin Zhang, University of Electronic Science and Technology of China, China
- Track 5. Next-Generation Wireless Networks (6G & Beyond)**
Chair: Ning Xu, Wuhan University of Technology, China
Co-Chair: Dan Niu, Southeast University, China
Co-Chair: Xianyang Jiang, Wuhan University, China
- Track 6. Green and Sustainable Communication Networks**
- Track 7. Advanced Integrated Circuits for AI and Machine Learning**
- Track 8. RF, Analog, and Mixed-Signal Circuits**
- Track 9. Signal Processing, Mixed-Signal & Sensor Integration**
- Track 10. Power Management and Energy-Harvesting Circuits**
- Track 11. Emerging Devices, Photonics & Beyond-CMOS Integration**

Critical Dates

Submission Due	Notification Date	Registration Due
Apr.25, 2026	May.15, 2026	May.30, 2026

Contact Us

Conference Secretariat: Ms. Tammy Lee

Email: icccas@vip.163.com

Advisory Chairs

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 Division I Director of IEEE; President of the IEEE CAS Society, VP Region 8 of IEEE CAS (1995-1997)
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 Peiyuan Zhan, Fuzhou University, China
 Xin Wu, Xiamen University, China

Award Chairs

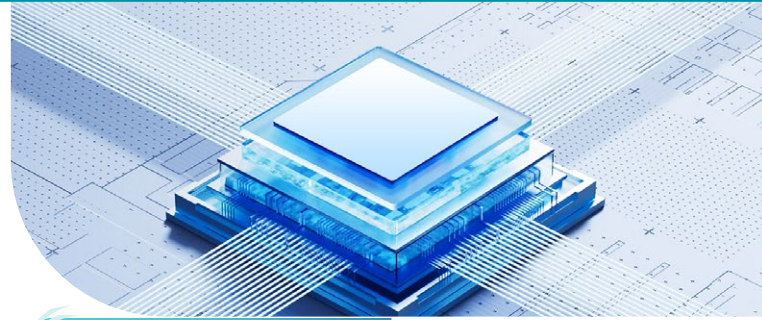
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Publication History

Accepted and presented papers of 14-year ICCAS have been successfully published and indexed by EI Compendex & Scopus.
 ICCAS 2025: Wuhan, China - ISBN: 979-8-3315-4477-5 (The papers were published 3 months after conference and were indexed 1 month after online.)

ICCCAS 2024: Xiamen, China - ISBN: 979-8-3503-8627-1
 ICCAS 2023: Singapore - ISBN: 978-981-97-2635-6
 ICCAS 2022: Online - ISBN: 978-1-6654-6989-0
 ICCAS 2018: Chengdu, China - ISBN: 978-1-5386-9387-2
 ICCAS 2013: Chengdu, China - ISBN: 978-1-4799-3051-7
 ICCAS 2010: Chengdu, China - ISBN: 978-1-4244-8224
 ICCAS 2009: Milpitas, CA, USA - ISBN: 978-1-4244-4886-9
 ICCAS 2008: Xiamen, China - ISBN: 978-1-4244-2063-6
 ICCAS 2007: Kokura, Japan - ISBN: 978-1-4244-1473-4
 ICCAS 2006: Guilin, China - ISBN: 0-7803-9584-0
 ICCAS 2005: Hong Kong, China - ISBN: 0-7803-9015-6
 ICCAS 2004: Chengdu, China - ISBN: 0-7803-8647-7
 ICCAS 2002: Chengdu, China - ISBN: 0-7803-7547-5

More info, please visit: <http://www.icccas.org/history.html>

Conference Awards

Outstanding Young Scholar Award – Deadline: June 5, 2026

Eligibility: Authors within the age of 40 by June 30 with a doctor degree.



- ★ Best Reviewer Award
- ★ Best Student Paper Award (Eligibility: University Students Only)
- ★ Best Paper Award (Eligibility: All Conference Accepted Papers)
- ★ Excellent Oral Presentation Award
- ★ Excellent Poster Presentation Award

For details, please visit: <http://www.icccas.org/award.html>

Submission Guideline

Submission Type:

Full Paper (English, no less than 4 pages normally, 10 pages maximum. 5-6 pages are recommended)

Abstract (English, within 300 words)

Submission Method:

EC Online Submission System:

<https://easychair.org/account2/signin?l=8160665891444084903>

Email Submission: icccas@vip.163.com

More details, please access: <https://www.icccas.org/sub.html>

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